

MACUSPEC HT 360

HIGH THROWING POWER DC ACID COPPER METALLIZATION



Pulse plating performance in your DC line for 8:1 aspect ratio through holes.

ZERO EQUIPMENT UPGRADES.

Efficiency: Excellent microdistribution at 20-30 ASF means 2x plating speeds vs. conventional DC baths.

Simplicity: Drop-in replacement in your existing equipment. No need for upgrades.

Quality: Fully analyzable means greater control over plating operation enabling higher technology manufacturing.